Q4 2023 Investor Conference

February 6th, 2024





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Review of Operations



Q4 2023 Financial Results

(thousands of NT dollars)

	Q4 2023 (unaudited)	Q3 2023	Change (QoQ)	Q4 2022	Change (YoY)	FY 2023 (unaudited)	FY 2022	Change (YoY)
Revenue	898,858	787,091	14.2%	902,704	-0.4%	3,050,325	3,216,711	-5.2%
Gross Margin	100%	100%	-	100%	-	100%	100%	-
Operating Expenses	359,330	369,873	-2.9%	368,090	-2.4%	1,357,725	1,363,293	-0.4%
Operating Income	539,528	417,218	29.3%	534,614	0.9%	1,692,600	1,853,418	-8.7%
Operating Margin	60.0%	53.0%	7.0ppts	59.2%	0.8ppt	55.5%	57.6%	-2.1ppts
*Net Income	403,753	405,903	-0.5%	430,536	-6.2%	1,474,443	1,611,909	-8.5%
Net Margin	44.5%	51.5%	-7.0ppts	47.6%	-3.1ppts	48.0%	49.9%	-1.9ppts
EPS (NT\$)	5.41	5.44	-0.6%	5.77	-6.2%	19.76	21.61	-8.6%
ROE	53.1%	57.2%	-4.1ppts	62.2%	-9.1ppts	48.5%	58.2%	-9.7ppts

*Net income attributable to Shareholders of the Company

Revenue across Different Streams





Revenue

NT\$ Thousands	Q4 2023	Q3 2023	Change (QoQ)	Q4 2022	Change (YoY)	FY 2023	FY 2022	Change (YoY)
Licensing	273,927	259,151	5.7%	205,104	33.6%	925,838	742,072	24.8%
Royalty	624,931	527,940	18.4%	697,600	-10.4%	2,124,487	2,474,639	-14.1%
Total	898,858	787,091	14.2%	902,704	-0.4%	3,050,325	3,216,711	-5.2%

Revenue by **Technology**

					Q4 2023					
		Total Revenue	;	Lic	Licensing Revenue			Royalty Revenue		
Technology	% of Q4 Revenue	Change (QoQ)	Change (YoY)	% of Q4 Licensing	Change (QoQ)	Change (YoY)	% of Q4 Royalty	Change (QoQ)	Change (YoY)	
NeoBit	23.2%	11.2%	-22.3%	26.3%	1.4%	97.9%	21.9%	17.1%	-41.1%	
NeoFuse	65.6%	18.1%	7.2%	42.8%	18.0%	18.3%	75.5%	18.2%	4.7%	
PUF-Based	3.3%	-47.8%	-35.0%	10.9%	-47.9%	-29.0%	0.0%	87.2%	-97.8%	
МТР	7.9%	64.1%	85.3%	20.0%	74.4%	99.1%	2.6%	37.1%	50.5%	

			FY 2023					
	thnology % of FY Change Revenue (YoY)		Licensing	Revenue	Royalty Revenue			
Technology			% of FY Change Licensing (YoY)		% of FY Royalty	Change (YoY)		
NeoBit	25.5%	-27.1%	24.6%	48.2%	25.9%	-39.8%		
NeoFuse	63.3%	3.4%	43.3%	4.3%	71.9%	3.2%		
PUF-Based	4.3%	7.4%	14.2%	13.4%	0.0%	-87.1%		
МТР	6.9%	30.6%	17.9%	88.4%	2.2%	-38.1%		

Royalty Revenue by Wafer Size

Q4 Royalty Breakdown



- 8-inch wafers contributed 37.8% of royalty, up 23.4% sequentially but down 28.5% yearly.
- 12-inch wafers contributed 62.2% of royalty, up 15.5% QoQ and up 5.9% YoY.

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Wefer Size		Q4 2023		FY 2023			
water Size	% of Q4	Change (QoQ)	Change (YoY)	% of FY	Change (YoY)		
8-Inch	37.8%	23.4%	-28.5%	41.1%	-27.7%		
12-Inch	62.2%	15.5%	5.9%	58.9%	-1.3%		

Future Outlook



Future Outlook

Licensing & Royalty:

- Licensing:
 - Strong licensing demand will continue to drive the growth momentum of licensing fees.
- Royalties:
 - We expect royalties in the first quarter to be temporarily affected by a customer moving to more advanced node, resulting in a single-digit QoQ decline but growth YoY.
 - Overall, revenue will decline by single digits quarterly, but increase by double-digits yearly.

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Future Outlook

New IP Technology & Business Development:

- Specialty processes (HV, HK, BCD, embedded flash, and emerging memory):
 - There will be more foundry technology licensing this quarter.
 - Per wafer royalty ASP will increase due to ongoing development into more advanced nodes.
 - The continued adoption of RRAM by more customers will drive increasing applications and contribute to royalty growth in the future.
- Advanced processes:
 - Last quarter, we successfully licensed our 3nm OTP and PUF technology to a US foundry customer and will be collaborating on the development of the most leading processes.
 - PUF-based security has been successfully adopted in a leading US high-performance computing (HPC) customer's related application.
 - There are multiple projects in 3/4/5nm under progress.

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Enhancing Security from AI Servers to AI Edge Computing



eMemory's Contribution to AI .

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- Al will be widely adopted from Edge Devices to Data Centers in the future.
- Al systems consists of many components including:

Computation and Processing	Storage	Sensing and Acting
 CPU GPU DPU Accelerators 	 SRAM DRAM/DRAM Modules CXL SSD HDD 	SensorsActuators

• eMemory's IP OTP/MTP/Root of Trust (PUFrt) have started to be deployed on all the above components.

Example: eMemory Helps Memory -

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• eMemory's security IP and OTP/MTP IP 1) ensure data security and 2) improve yield for SRAM and DRAM.



eMemory Solutions for Al Servers .

eMemory IPs will play a crucial role in AI servers.



eMemory Solutions for Al Edge Devices .

 eMemory solutions are used in 1) protecting AI models, 2) trimming analog devices, and 3) data and program storage in NeoFlash.



- A. Root of Trust to provide:
 - 1. Key Storage
 - 2. Key Generation
 - Cryptographic processing for protecting AI model, input data, and output results
 - 4. Confidential Computing
- OTP is needed for trimming analog circuits in Sensors and Actuators
- C. NeoFlash will be used to replace conventional eFlash due to much lower cost

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D. Memory repair

IR Website



IR Website Demo.







Appendix



Company Overview

eMemory is the global leader of embedded non-volatile memory IP



Founded

Based in Hsinchu, Taiwan. IPO in 2011. Over 53M wafers shipped.

1170+ Patents Issued

200 pending patents. 351 employees with 68% R&D personnel.

Best IP Partner

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TSMC Best IP Partner Award since 2010.

Quarterly Revenue Pattern

- 1st month: Receive License Fees of the month and Royalty from most foundries on previous quarter's wafer shipments.
- 2nd month: Receive License Fees of the month and Royalty from other foundries.
- 3rd month: License Fees Only.



Quarterly Number of New Tape-outs



Worldwide Customers

Our IP solutions are adopted by leading foundries, IDMs and fabless worldwide



Business Model

Recurring royalty is the backbone of our business



Technology Licenses

Number of Licenses

Year	2016	2017	2018	2019	2020	2021	2022	2023
License	43	20	26	18	28	32	29	48

Note: Terms (including number of process platforms and licensing fees) for each technology license are set contractually. Payments are made according to set milestones, and there are no particular seasonal factors involved.

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New Technology Under Development

- New technologies are being developed for 147 platforms by Q4 2023.
- 14 licensing contracts were signed.

Technology	3nm	4/5nm	6/7nm	12/16nm	22/28nm	40nm	55/65nm	80/90nm	0.11~ 0.13um	0.15~ 0.18um	>0.25um
NeoBit	-	-	-	-	-	-	2	2	13	9	1
NeoFuse	3	1	1	6	15	6	16	9	4	4	-
PUF-Based	1	3	-	1	1	-	1	-	-	-	-
МТР	-	-	-	-	1	1	6	7	13	20	-

Note: As of of December 31st, 2023

Embedded Wisely, Embedded Widely

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Technology Development

Developments by process nodes

12" Fabs	Production	Development	IP Туре	Process Type
3nm	0	4	OTP, PUF	FF, FFP
4/5nm	4	4	OTP, PUF	FF, FF-Auto
6/7nm	4	1	OTP, PUF	FF, FF+
12/16nm	9	7	OTP, PUF	FF, FF+, FFC. FFC+, LPP, DRAM, HV
22/28nm	50	17	OTP, PUF, MTP	LP/ULP/ULL, HPC/HPC+, HV-OLED, DRAM, SOI, ReRAM, MRAM, E-Flash, BCD
40nm	23	7	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, ReRAM, BCD+
55/65nm	44	25	OTP, PUF, MTP	LP/ULP, E-Flash, HV-DDI/OLED, DRAM, CIS, BCD, PM
80/90nm	27	15	OTP, MTP	HV-DDI/OLED, LP, Generic, BCD, CIS
0.11/0.13um	21	3	OTP, MTP	HV-DDI, BCD, Generic
0.15/0.18um	8	11	OTP, MTP	BCD, Generic
Total	190	94		

8" Fabs	Production	Development	IP Type	Process Type
80/90nm	9	3	OTP	HV-DDI, LL, BCD
0.11/0.13um	78	27	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Flash, SOI, Generic
0.152/0.16/0.18um	238	22	OTP, MTP	HV/HV-MR, BCD, LP/LL, CIS, Green, Generic
0.25um	42	1	OTP	BCD
0.3/0.35um	53	0	OTP, MTP	UHV, BCD
0.4/0.5um	11	0	OTP	UHV, BCD
Total	431	53		

Note: As of of December 31st, 2023



Embedded Wisely, Embedded Widely

For more information, please visit:

eMemory Website: <u>https://www.ememory.com.tw/</u> PUFsecurity Website: <u>https://www.pufsecurity.com/</u>

